



## GENERAL DESCRIPTION



The ICS874005 is a high performance Differential-to-LVDS Jitter Attenuator designed for use in PCI Express systems. In some PCI Express systems, such as those found in desktop PCs, the PCI Express clocks are generated from a low bandwidth, high phase noise PLL frequency synthesizer. In these systems, a jitter attenuator may be required to attenuate high frequency random and deterministic jitter components from the PLL synthesizer and from the system board. The ICS874005 has 3 PLL bandwidth modes: 200kHz, 400kHz, and 800kHz. The 200kHz mode will provide maximum jitter attenuation, but with higher PLL tracking skew and spread spectrum modulation from the motherboard synthesizer may be attenuated. The 400kHz provides an intermediate bandwidth that can easily track triangular spread profiles, while providing good jitter attenuation. The 800kHz bandwidth provides the best tracking skew and will pass most spread profiles, but the jitter attenuation will not be as good as the lower bandwidth modes. Because some 2.5Gb serdes have x20 multipliers while others have than x25 multipliers, the 874005 can be set for 1:1 mode or 5/4 multiplication mode (i.e. 100MHz input/125MHz output) using the F\_SEL pins.

The ICS874005 uses ICS 3<sup>rd</sup> Generation FemtoClock™ PLL technology to achieve the lowest possible phase noise. The device is packaged in a 24 Lead TSSOP package, making it ideal for use in space constrained applications such as PCI Express add-in cards.

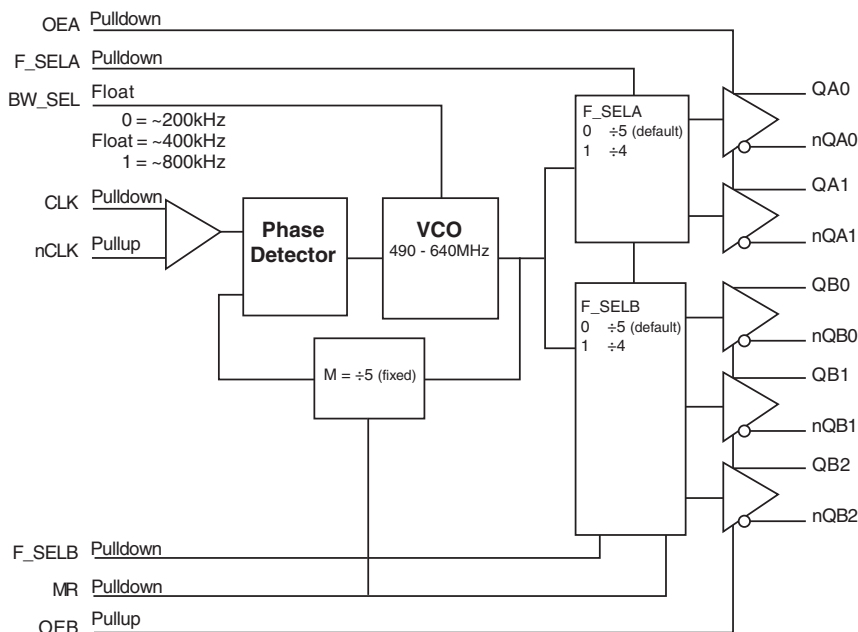
## FEATURES

- Five differential LVDS output pairs
- One differential clock input
- CLK and nCLK supports the following input types: LVPECL, LVDS, LVHSTL, SSTL, HCSL
- Output frequency range: 98MHz - 160MHz
- Input frequency range: 98MHz - 128MHz
- VCO range: 490MHz - 640MHz
- Cycle-to-cycle jitter: 30ps (maximum)
- 3.3V operating supply
- 3 bandwidth modes allow the system designer to make jitter attenuation/tracking skew design trade-offs
- 0°C to 70°C ambient operating temperature
- Available in both standard and lead-free RoHS compliant packages

## PLL BANDWIDTH

**BW\_SEL**  
 0 = PLL Bandwidth: ~200kHz  
 Float = PLL Bandwidth: ~400kHz (Default)  
 1 = PLL Bandwidth: ~800kHz

## BLOCK DIAGRAM



## PIN ASSIGNMENT

|        |    |    |        |
|--------|----|----|--------|
| nQB2   | 1  | 24 | QB2    |
| nQA1   | 2  | 23 | VDDO   |
| QA1    | 3  | 22 | QB1    |
| VDDO   | 4  | 21 | nQB1   |
| QA0    | 5  | 20 | QB0    |
| nQA0   | 6  | 19 | nQB0   |
| MR     | 7  | 18 | F_SELB |
| BW_SEL | 8  | 17 | OEB    |
| VDDA   | 9  | 16 | GND    |
| F_SELA | 10 | 15 | GND    |
| VDD    | 11 | 14 | nCLK   |
| OEA    | 12 | 13 | CLK    |

### ICS874005

#### 24-Lead TSSOP

4.40mm x 7.8mm x 0.92mm  
 package body  
**G Package**  
 Top View



**TABLE 1. PIN DESCRIPTIONS**

| Number | Name             | Type   |                     | Description                                                                                                                                                                                                                                                     |
|--------|------------------|--------|---------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1, 24  | nQB2, QB2        | Output |                     | Differential output pair. LVDS interface levels.                                                                                                                                                                                                                |
| 2, 3   | nQA1, QA1        | Output |                     | Differential output pair. LVDS interface levels.                                                                                                                                                                                                                |
| 4, 23  | V <sub>DDO</sub> | Power  |                     | Output supply pins.                                                                                                                                                                                                                                             |
| 5, 6   | QA0, nQA0        | Output |                     | Differential output pair. LVDS interface levels.                                                                                                                                                                                                                |
| 6      | nFB_OUT          | Output |                     | Inverting differential feedback output.                                                                                                                                                                                                                         |
| 7      | MR               | Input  | Pulldown            | Active HIGH Master Reset. When logic HIGH, the internal dividers are reset causing the true outputs (nQx) to go low and the inverted outputs (Qx) to go high. When logic LOW, the internal dividers and the outputs are enabled. LVCMOS/LVTTL interface levels. |
| 8      | BW_SEL           | Input  | Pullup/<br>Pulldown | PLL Bandwidth input. See Table 3B.                                                                                                                                                                                                                              |
| 9      | V <sub>DDA</sub> | Power  |                     | Analog supply pin.                                                                                                                                                                                                                                              |
| 10     | F_SELA           | Input  | Pulldown            | Frequency select pin for QAx/nQAx outputs. LVCMOS/LVTTL interface levels.                                                                                                                                                                                       |
| 11     | V <sub>DD</sub>  | Power  |                     | Core supply pin.                                                                                                                                                                                                                                                |
| 12     | OEA              | Input  | Pullup              | Output enable pin for QA pins. When HIGH, the QAx/nQAx outputs are active. When LOW, the QAx/nQAx outputs are in a high impedance state. LVCMOS/LVTTL interface levels.                                                                                         |
| 13     | CLK              | Input  | Pulldown            | Non-inverting differential clock input.                                                                                                                                                                                                                         |
| 14     | nCLK             | Input  | Pullup              | Inverting differential clock input.                                                                                                                                                                                                                             |
| 15, 16 | GND              | Power  |                     | Power supply ground.                                                                                                                                                                                                                                            |
| 17     | OEB              | Input  | Pullup              | Output enable pin for QB pins. When HIGH, the QBx/nQBx outputs are active. When LOW, the QBx/nQBx outputs are in a high impedance state. LVCMOS/LVTTL interface levels.                                                                                         |
| 18     | F_SELB           | Input  | Pulldown            | Frequency select pin for QBx/nQBx outputs. LVCMOS/LVTTL interface levels.                                                                                                                                                                                       |
| 19, 20 | nQB0, QB0        | Output |                     | Differential output pair. LVDS interface levels.                                                                                                                                                                                                                |
| 21, 22 | nQB1, QB1        | Output |                     | Differential output pair. LVDS interface levels.                                                                                                                                                                                                                |

NOTE: *Pullup* and *Pulldown* refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

**TABLE 2. PIN CHARACTERISTICS**

| Symbol                | Parameter               | Test Conditions | Minimum | Typical | Maximum | Units |
|-----------------------|-------------------------|-----------------|---------|---------|---------|-------|
| C <sub>IN</sub>       | Input Capacitance       |                 |         | 4       |         | pF    |
| R <sub>PULLUP</sub>   | Input Pullup Resistor   |                 |         | 51      |         | kΩ    |
| R <sub>PULLDOWN</sub> | Input Pulldown Resistor |                 |         | 51      |         | kΩ    |

**TABLE 3A. OUTPUT ENABLE FUNCTION TABLE**

| Inputs | Outputs  |          |
|--------|----------|----------|
|        | OEA/nQAx | QBx/nQBx |
| 0      | HiZ      | HiZ      |
| 1      | Enabled  | Enabled  |

**TABLE 3B. PLL BANDWIDTH/PLL BYPASS CONTROL**

| Inputs | PLL Bandwidth |
|--------|---------------|
| PLL_BW |               |
| 0      | ~200kHz       |
| 1      | ~800kHz       |
| Float  | ~400kHz       |



#### ABSOLUTE MAXIMUM RATINGS

|                                          |                           |
|------------------------------------------|---------------------------|
| Supply Voltage, $V_{DD}$                 | 4.6V                      |
| Inputs, $V_I$                            | -0.5V to $V_{DD} + 0.5V$  |
| Outputs, $V_O$                           | -0.5V to $V_{DDO} + 0.5V$ |
| Package Thermal Impedance, $\theta_{JA}$ | 70°C/W (0 lfpm)           |
| Storage Temperature, $T_{STG}$           | -65°C to 150°C            |

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

**TABLE 4A. POWER SUPPLY DC CHARACTERISTICS,  $V_{DD} = V_{DDA} = V_{DDO} = 3.3V \pm 5\%$ ,  $T_A = 0^\circ\text{C}$  TO  $70^\circ\text{C}$**

| Symbol    | Parameter             | Test Conditions | Minimum | Typical | Maximum | Units |
|-----------|-----------------------|-----------------|---------|---------|---------|-------|
| $V_{DD}$  | Core Supply Voltage   |                 | 3.135   | 3.3     | 3.465   | V     |
| $V_{DDA}$ | Analog Supply Voltage |                 | 3.135   | 3.3     | 3.465   | V     |
| $V_{DDO}$ | Output Supply Voltage |                 | 3.135   | 3.3     | 3.465   | V     |
| $I_{DD}$  | Power Supply Current  |                 |         |         | 85      | mA    |
| $I_{DDA}$ | Analog Supply Current |                 |         |         | 15      | mA    |
| $I_{DDO}$ | Output Supply Current |                 |         |         | 115     | mA    |

**TABLE 4B. LVCMOS/LVTTL DC CHARACTERISTICS,  $V_{DD} = V_{DDA} = V_{DDO} = 3.3V \pm 5\%$ ,  $T_A = 0^\circ\text{C}$  TO  $70^\circ\text{C}$**

| Symbol   | Parameter          | Test Conditions              | Minimum                        | Typical | Maximum          | Units         |
|----------|--------------------|------------------------------|--------------------------------|---------|------------------|---------------|
| $V_{IH}$ | Input High Voltage | OEA, OEB, MR, F_SELA, F_SELB | 2                              |         | $V_{DD} + 0.3$   | V             |
|          |                    | BW_SEL                       | $V_{DD} - 0.4$                 |         |                  | V             |
| $V_{IL}$ | Input Low Voltage  | OEA, OEB, MR, F_SELA, F_SELB | -0.3                           |         | 0.8              | V             |
|          |                    | BW_SEL                       |                                |         | 0.4              | V             |
| $V_{IM}$ | Input Mid Voltage  | BW_SEL                       | $V_{DD}/2 - 0.1$               |         | $V_{DD}/2 + 0.1$ | V             |
| $I_{IH}$ | Input High Current | OEA, OEB                     | $V_{DD} = V_{IN} = 3.465V$     |         | 5                | $\mu\text{A}$ |
|          |                    | F_SELA, F_SELB, MR, BW_SEL   | $V_{DD} = V_{IN} = 3.465V$     |         | 150              | $\mu\text{A}$ |
| $I_{IL}$ | Input Low Current  | BW_SEL, OEA, OEB             | $V_{DD} = 3.465V, V_{IN} = 0V$ | -150    |                  | $\mu\text{A}$ |
|          |                    | MR, F_SELA, F_SELB           | $V_{DD} = 3.465V, V_{IN} = 0V$ | -5      |                  | $\mu\text{A}$ |



**TABLE 4C. DIFFERENTIAL DC CHARACTERISTICS,  $V_{DD} = V_{DDA} = V_{DDO} = 3.3V \pm 5\%$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$**

| Symbol    | Parameter                            | Test Conditions | Minimum                    | Typical | Maximum         | Units   |
|-----------|--------------------------------------|-----------------|----------------------------|---------|-----------------|---------|
| $I_{IH}$  | Input High Current                   | CLK             | $V_{DD} = V_{IN} = 3.465V$ |         | 150             | $\mu A$ |
|           |                                      | nCLK            | $V_{DD} = V_{IN} = 3.465V$ | 5       |                 |         |
| $I_{IL}$  | Input Low Current                    | CLK             | $V_{DD} = V_{IN} = 3.465V$ |         | 150             | $\mu A$ |
|           |                                      | nCLK            | $V_{DD} = V_{IN} = 3.465V$ | -150    |                 |         |
| $V_{PP}$  | Peak-to-Peak Input Voltage           |                 | 0.15                       |         | 1.3             | V       |
| $V_{CMR}$ | Common Mode Input Voltage; NOTE 1, 2 |                 | GND + 0.5                  |         | $V_{DD} - 0.85$ | V       |

NOTE 1: Common mode voltage is defined as  $V_{IH}$ .

NOTE 2: For single ended applications, the maximum input voltage for CLK, nCLK is  $V_{DD} + 0.3V$ .

**TABLE 4D. LVDS DC CHARACTERISTICS,  $V_{DD} = V_{DDA} = V_{DDO} = 3.3V \pm 5\%$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$**

| Symbol          | Parameter                   | Test Conditions | Minimum | Typical | Maximum | Units |
|-----------------|-----------------------------|-----------------|---------|---------|---------|-------|
| $V_{OD}$        | Differential Output Voltage |                 | 275     | 375     | 485     | mV    |
| $\Delta V_{OD}$ | $V_{OD}$ Magnitude Change   |                 |         |         | 50      | mV    |
| $V_{OS}$        | Offset Voltage              |                 | 1.2     | 1.35    | 1.5     | V     |
| $\Delta V_{OS}$ | $V_{OS}$ Magnitude Change   |                 |         |         | 50      | mV    |

**TABLE 5. AC CHARACTERISTICS,  $V_{DD} = V_{DDA} = V_{DDO} = 3.3V \pm 5\%$ ,  $T_A = 0^\circ C$  TO  $70^\circ C$**

| Symbol        | Parameter                     | Test Conditions | Minimum | Typical | Maximum | Units |
|---------------|-------------------------------|-----------------|---------|---------|---------|-------|
| $f_{MAX}$     | Output Frequency              |                 | 98      |         | 160     | MHz   |
| $t_{jit(cc)}$ | Cycle-to-Cycle Jitter, NOTE 1 |                 |         | 15      | 30      | ps    |
| $t_{sk(o)}$   | Output Skew; NOTE 2, 3        |                 |         |         | 90      | ps    |
| $t_R / t_F$   | Output Rise/Fall Time         | 20% to 80%      | 300     |         | 550     | ps    |
| odc           | Output Duty Cycle             |                 | 48      |         | 52      | %     |

NOTE 1: This parameter is defined in accordance with JEDEC Standard 65.

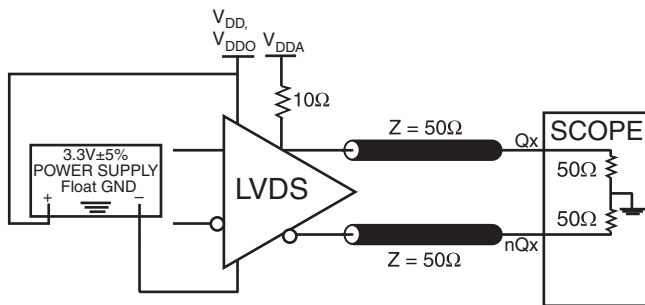
NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions.

Measured at  $V_{DDO}/2$ .

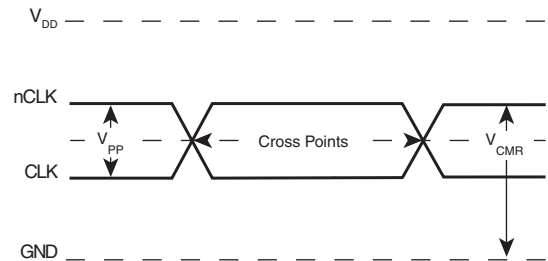
NOTE 3: These parameters are guaranteed by characterization. Not tested in production.



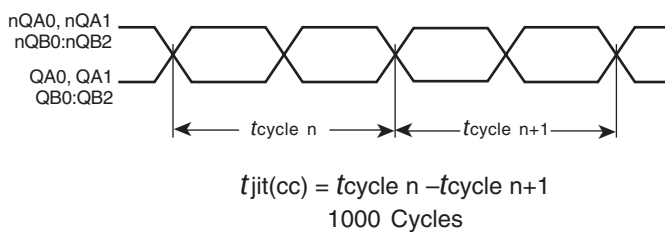
## PARAMETER MEASUREMENT INFORMATION



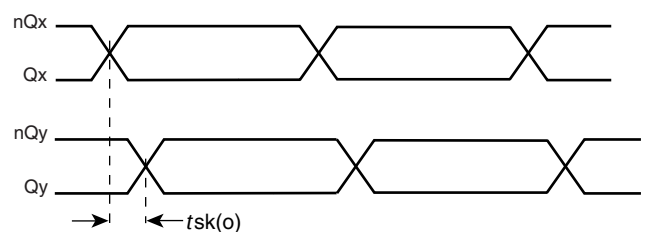
**3.3V LVDS OUTPUT LOAD AC TEST CIRCUIT**



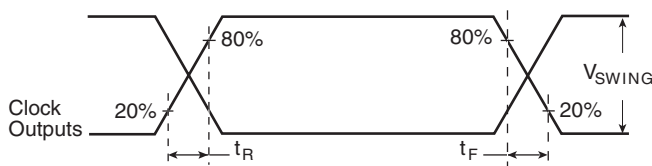
**DIFFERENTIAL INPUT LEVEL**



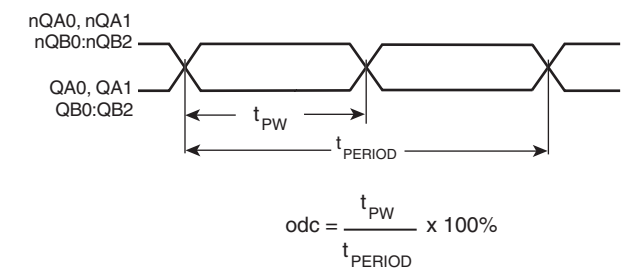
**CYCLE-TO-CYCLE JITTER**



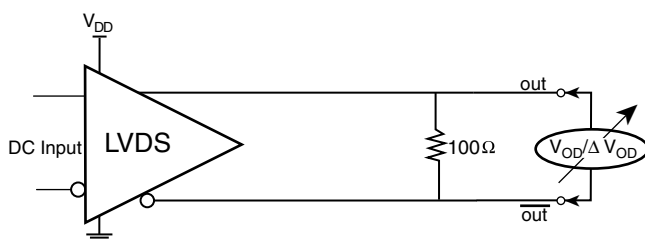
**OUTPUT SKEW**



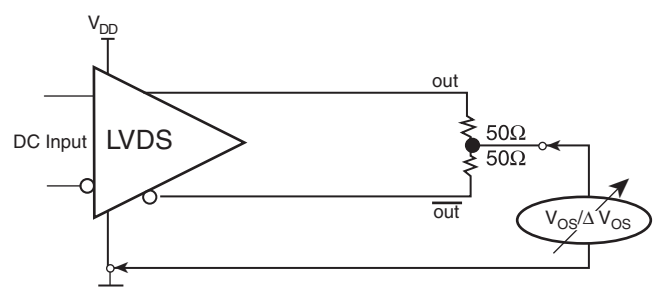
**OUTPUT RISE/FALL TIME**



**OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD**



**DIFFERENTIAL OUTPUT VOLTAGE SETUP**



**OFFSET VOLTAGE SETUP**



## APPLICATION INFORMATION

### POWER SUPPLY FILTERING TECHNIQUES

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. The ICS874005 provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL.  $V_{DD}$ ,  $V_{DDA}$ , and  $V_{DDO}$  should be individually connected to the power supply plane through vias, and bypass capacitors should be used for each pin. To achieve optimum jitter performance, power supply isolation is required. *Figure 1* illustrates how a  $10\Omega$  resistor along with a  $10\mu F$  and a  $.01\mu F$  bypass capacitor should be connected to each  $V_{CCA}$  pin.

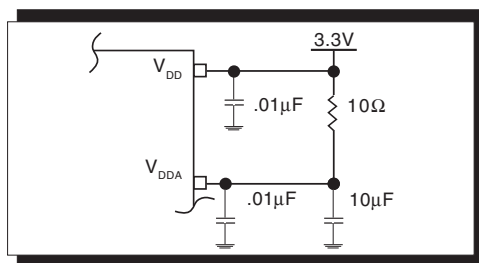


FIGURE 1. POWER SUPPLY FILTERING

### WIRING THE DIFFERENTIAL INPUT TO ACCEPT SINGLE ENDED LEVELS

*Figure 2* shows how the differential input can be wired to accept single ended levels. The reference voltage  $V_{REF} = V_{DD}/2$  is generated by the bias resistors  $R1$ ,  $R2$  and  $C1$ . This bias circuit should be located as close as possible to the input pin. The ratio

of  $R1$  and  $R2$  might need to be adjusted to position the  $V_{REF}$  in the center of the input voltage swing. For example, if the input clock swing is only 2.5V and  $V_{DD} = 3.3V$ ,  $V_{REF}$  should be 1.25V and  $R2/R1 = 0.609$ .

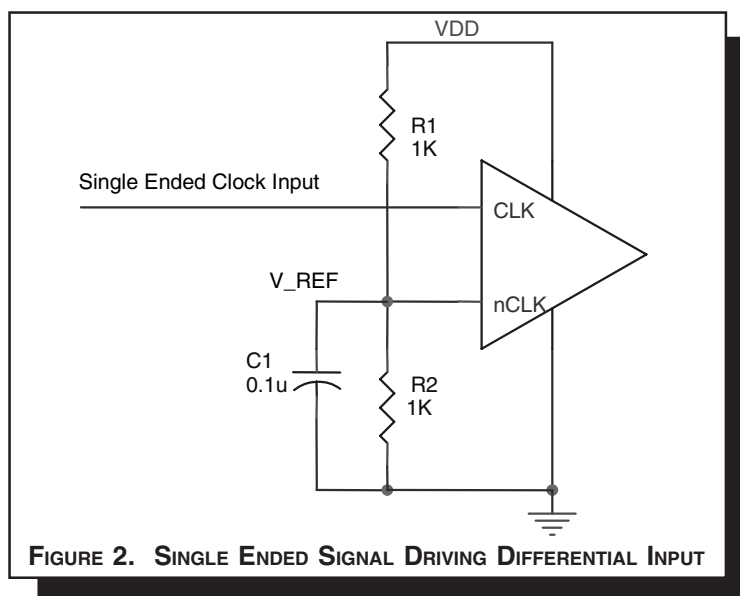


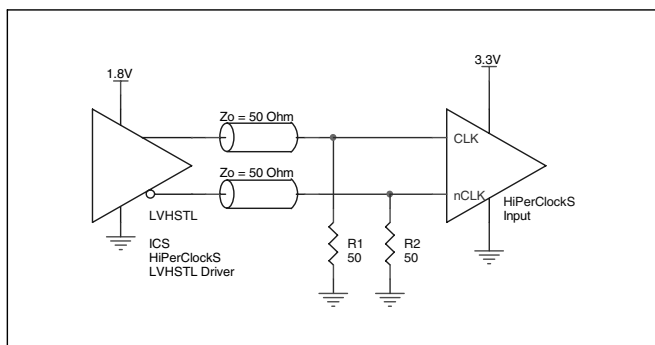
FIGURE 2. SINGLE ENDED SIGNAL DRIVING DIFFERENTIAL INPUT



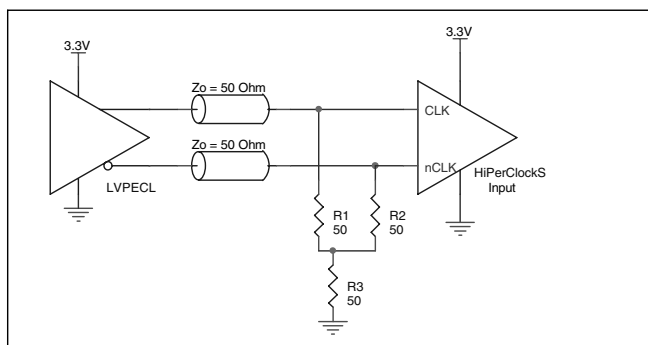
## DIFFERENTIAL CLOCK INPUT INTERFACE

The CLK /nCLK accepts LVDS, LVPECL, LVHSTL, SSTL, HCSL and other differential signals. Both  $V_{\text{SWING}}$  and  $V_{\text{OH}}$  must meet the  $V_{\text{PP}}$  and  $V_{\text{CMR}}$  input requirements. Figures 3A to 3D show interface examples for the HiPerClockS CLK/nCLK input driven by the most common driver types. The input interfaces suggested

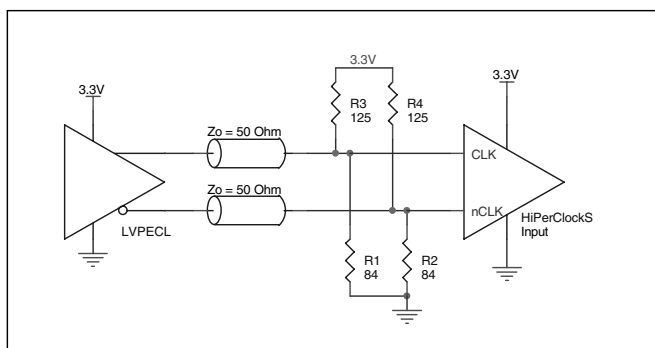
here are examples only. Please consult with the vendor of the driver component to confirm the driver termination requirements. For example in Figure 3A, the input termination applies for ICS HiPerClockS LVHSTL drivers. If you are using an LVHSTL driver from another vendor, use their termination recommendation.



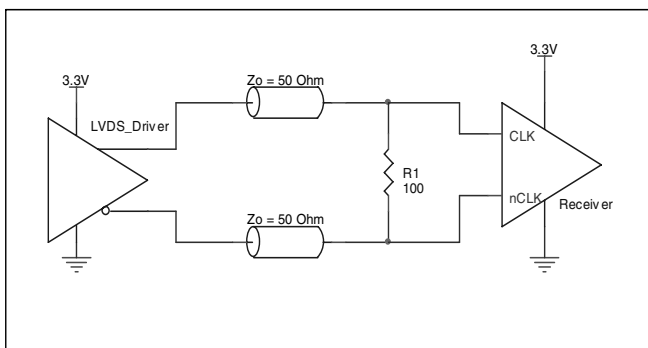
**FIGURE 3A. HiPerClockS CLK/nCLK INPUT DRIVEN BY ICS HiPerClockS LVHSTL DRIVER**



**FIGURE 3B. HiPerClockS CLK/nCLK INPUT DRIVEN BY 3.3V LVPECL DRIVER**



**FIGURE 3C. HiPerClockS CLK/nCLK INPUT DRIVEN BY 3.3V LVPECL DRIVER**



**FIGURE 3D. HiPerClockS CLK/nCLK INPUT DRIVEN BY 3.3V LVDS DRIVER**

## RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

### INPUTS:

#### LVCMOS CONTROL PINS:

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A 1k $\Omega$  resistor can be used.

### OUTPUTS:

#### LVDS

All unused LVDS output pairs can be either left floating or terminated with 100 $\Omega$  across. If they are left floating, we recommend that there is no trace attached.



## LVDS DRIVER TERMINATION

A general LVDS interface is shown in Figure 4. In a 100Ω differential transmission line environment, LVDS drivers require a matched load termination of 100Ω across near

the receiver input. For a multiple LVDS outputs buffer, if only partial outputs are used, it is recommended to terminate the un-used outputs.

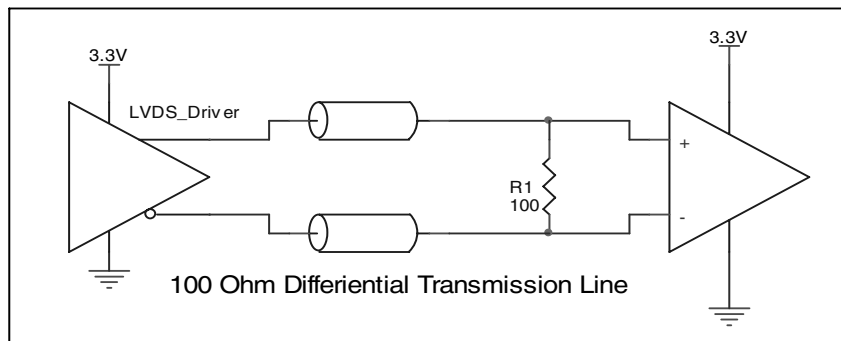


FIGURE 4. TYPICAL LVDS DRIVER TERMINATION

## SCHEMATIC EXAMPLE

Figure 5 shows an example of ICS874005 application schematic. In this example, the device is operated at  $V_{DD}=3.3V$ . The

decoupling capacitor should be located as close as possible to the power pin. The input is driven by a 3.3V LVPECL driver.

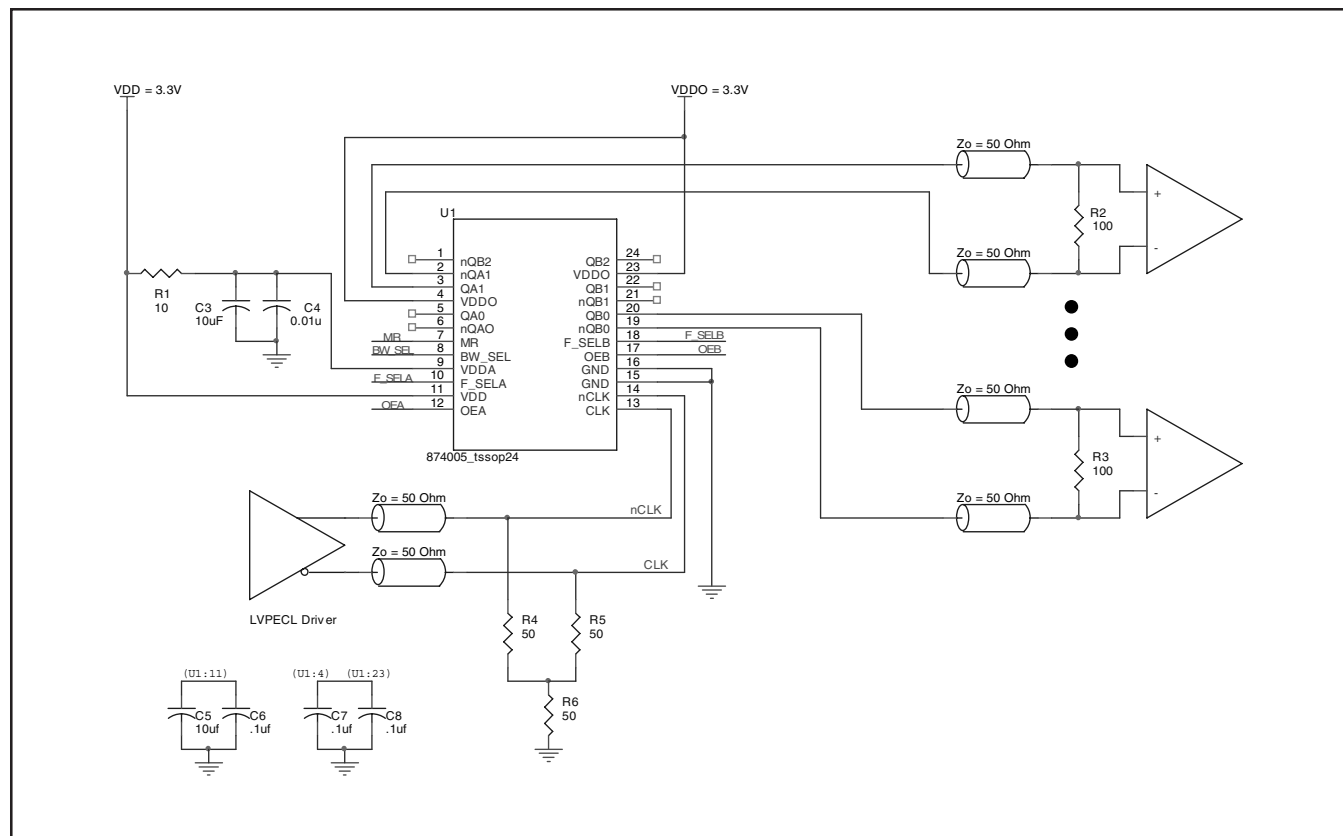


FIGURE 5. ICS874005 SCHEMATIC EXAMPLE



## POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the ICS874005. Equations and example calculations are also provided.

### 1. Power Dissipation.

The total power dissipation for the ICS874005 is the sum of the core power plus the power dissipated in the load(s).

The following is the power dissipation for  $V_{DD} = 3.3V + 5\% = 3.465V$ , which gives worst case results.

- Power (core)<sub>MAX</sub> =  $V_{DD\_MAX} * (I_{DD\_MAX} + I_{DDA\_MAX}) = 3.465V * (85mA + 15mA) = \mathbf{346.5mW}$
- Power (outputs)<sub>MAX</sub> =  $V_{DDO\_MAX} * I_{DDO\_MAX} = 3.465V * 115mA = \mathbf{398.48mW}$

$$\mathbf{Total\ Power_{\_MAX} = 346.5mW + 398.48mW = 745mW}$$

### 2. Junction Temperature.

Junction temperature,  $T_j$ , is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

The equation for  $T_j$  is as follows:  $T_j = \theta_{JA} * Pd\_total + T_A$

$T_j$  = Junction Temperature

$\theta_{JA}$  = Junction-to-Ambient Thermal Resistance

$Pd\_total$  = Total Device Power Dissipation (example calculation is in section 1 above)

$T_A$  = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance  $\theta_{JA}$  must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 63°C/W per Table 6 below.

Therefore,  $T_j$  for an ambient temperature of 70°C with all outputs switching is:

$$70^\circ\text{C} + 0.745\text{W} * 63^\circ\text{C/W} = 117^\circ\text{C}. \text{ This is below the limit of } 125^\circ\text{C}.$$

This calculation is only an example.  $T_j$  will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

**TABLE 6. THERMAL RESISTANCE  $\theta_{JA}$  FOR 24-LEAD TSSOP, FORCED CONVECTION**

| $\theta_{JA}$ by Velocity (Linear Feet per Minute)                                                                  |        |        |        |
|---------------------------------------------------------------------------------------------------------------------|--------|--------|--------|
|                                                                                                                     | 0      | 200    | 500    |
| Multi-Layer PCB, JEDEC Standard Test Boards                                                                         | 70°C/W | 63°C/W | 60°C/W |
| <b>NOTE:</b> Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs. |        |        |        |



## RELIABILITY INFORMATION

**TABLE 7.  $\theta_{JA}$  VS. AIR FLOW TABLE FOR 24 LEAD TSSOP**

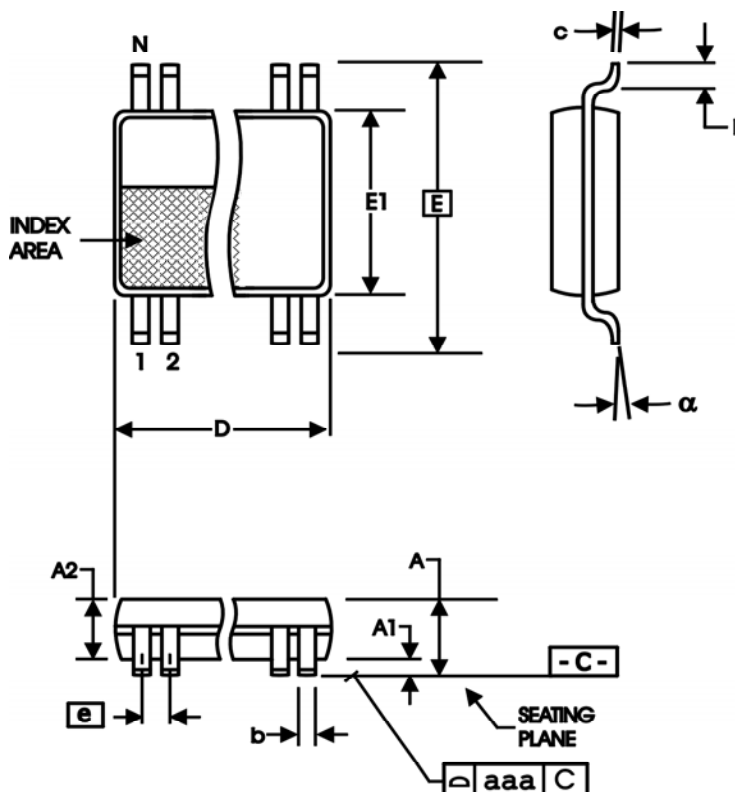
| <b><math>\theta_{JA}</math> by Velocity (Linear Feet per Minute)</b> |          |            |            |
|----------------------------------------------------------------------|----------|------------|------------|
|                                                                      | <b>0</b> | <b>200</b> | <b>500</b> |
| Multi-Layer PCB, JEDEC Standard Test Boards                          | 70°C/W   | 63°C/W     | 60°C/W     |

### TRANSISTOR COUNT

The transistor count for ICS874005 is: 1206



**PACKAGE OUTLINE - G SUFFIX FOR 24 LEAD TSSOP**



**TABLE 8. PACKAGE DIMENSIONS**

| SYMBOL   | Millimeters |         |
|----------|-------------|---------|
|          | Minimum     | Maximum |
| N        | 24          |         |
| A        | --          | 1.20    |
| A1       | 0.05        | 0.15    |
| A2       | 0.80        | 1.05    |
| b        | 0.19        | 0.30    |
| c        | 0.09        | 0.20    |
| D        | 7.70        | 7.90    |
| E        | 6.40 BASIC  |         |
| E1       | 4.30        | 4.50    |
| e        | 0.65 BASIC  |         |
| L        | 0.45        | 0.75    |
| $\alpha$ | 0°          | 8°      |
| aaa      | --          | 0.10    |

Reference Document: JEDEC Publication 95, MO-153



**TABLE 9. ORDERING INFORMATION**

| Part/Order Number | Marking     | Package                   | Shipping Packaging | Temperature |
|-------------------|-------------|---------------------------|--------------------|-------------|
| ICS874005AG       | ICS874005AG | 24 Lead TSSOP             | tube               | 0°C to 70°C |
| ICS874005AGT      | ICS874005AG | 24 Lead TSSOP             | 2500 tape & reel   | 0°C to 70°C |
| ICS874005AGLF     | TBD         | 24 Lead "Lead-Free" TSSOP | tube               | 0°C to 70°C |
| ICS874005AGLFT    | TBD         | 24 Lead "Lead-Free" TSSOP | 2500 tape & reel   | 0°C to 70°C |

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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